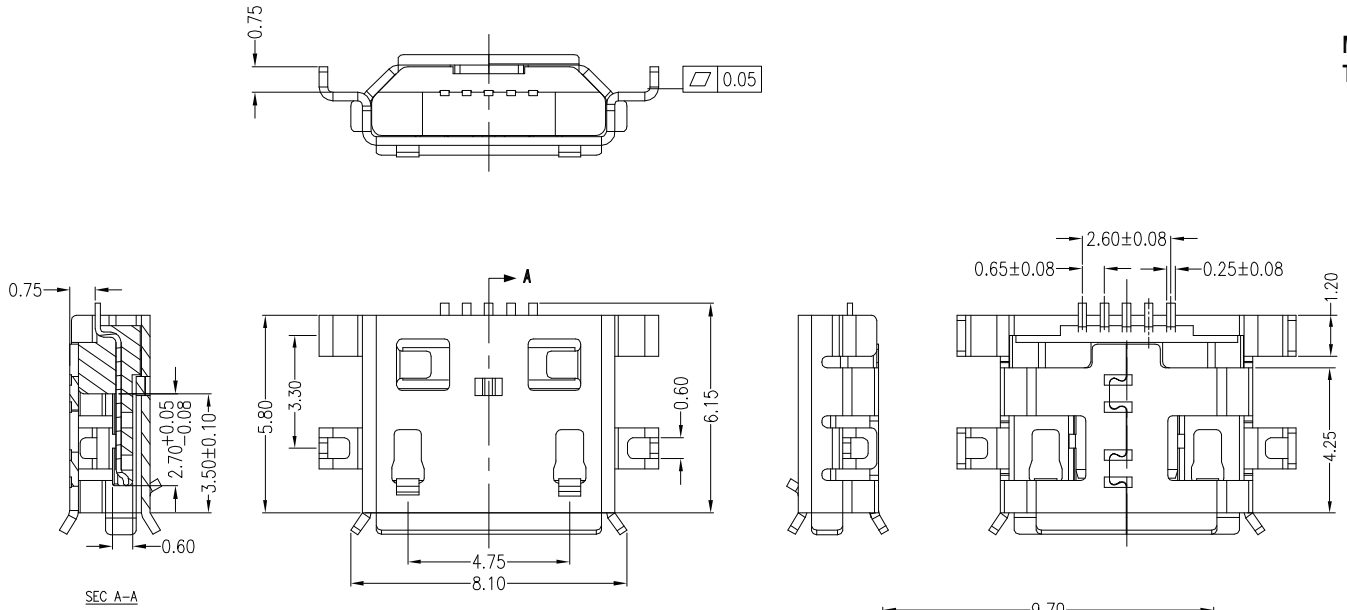
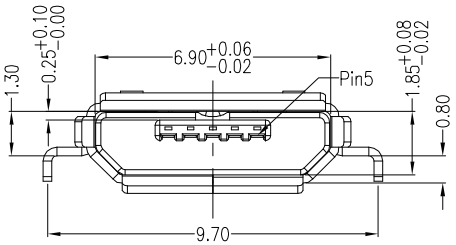
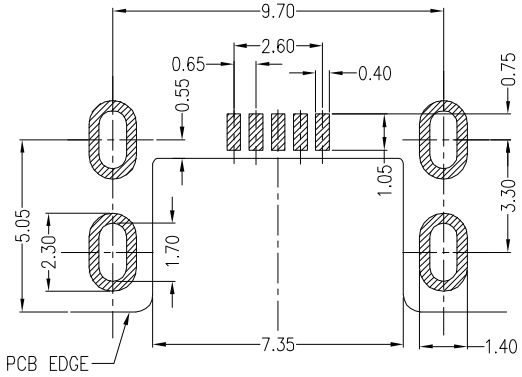
REV	ZONE	REVISION	DATE	DWG.

CMUB026 FMP - B P * N

- CMUB026: MICRO USB TYPE B
- FMP: F=OFFSET, M=SMD, P=WITH COVER TAB PIN
- B: COLOR B=BLACK
- P: CONTACT PLATING 1=GOLD FLASH, 2=3u", 3=5u", 4=15u", 5=30u"
- N: SHELL N=COPPER







RECOMMANDED PCB LAYOUT

Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v−0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:
- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 MΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: −30°C~80°C

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COMPUTER NO.	UNIT	SCALE	PART NAME
CMUB-S001-028	mm	1 : 1	MICRO USB TYPE B OFFSET, SMD

DWG.	Eric	DWG. DATE	2014-04-29
CKD.	Aaron	CKD. DATE	2014-04-29
APPD.		APPD. DATE	

TOLERANCE: 0.000mm ± 0.075mm; 0.00 mm ± 0.15 mm; 0.0 mm ± 0.25 mm

REV. A.0

MODEL	CMUB026FMP-BP*N	PAGE 1 OF 1